

REV.	ECH. NO.	APPD.
A	/	ZFY

NOTES:  
 1. MATERIAL:  
 MOLDING: LCP UL94 V-0  
 CONTACT: COPPER ALLOY.  
 GOLD PLATED Min ON CONTACT AREA, 100u" Min TIN (LEAD FREE) ON SOLDER AREA, SHELL: SUS201-H,T=0.30±0.03mm 50u" NICKEL PLATING OVER ALL.

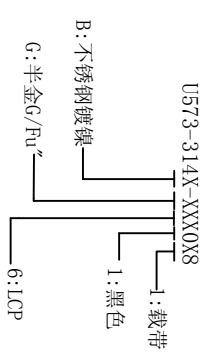
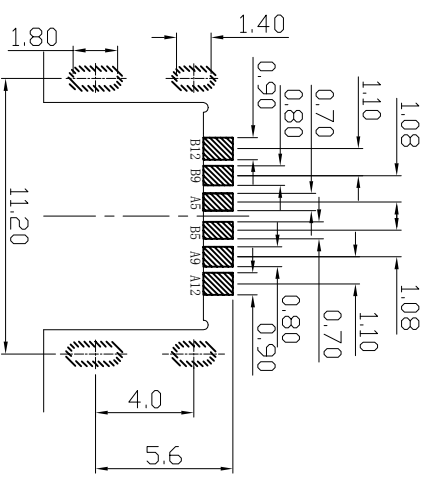
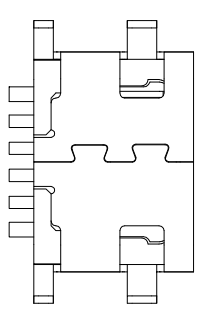
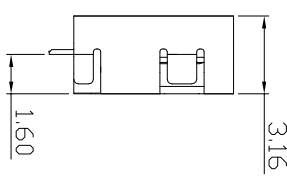
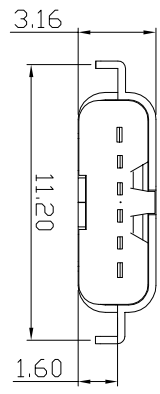
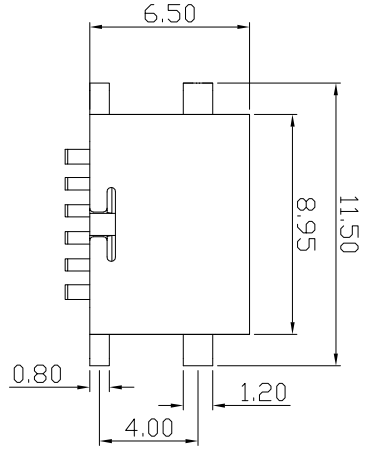
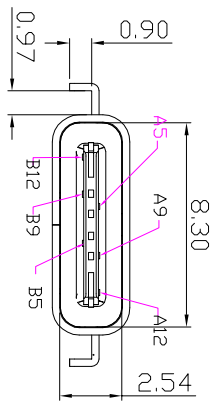
2. MECHANICAL:  
 INSERTION: 5~20N.  
 EXTRACTION: 8~20N AFTER TEST.  
 DURABILITY: 5000 CYCLES

3. ELECTRICAL:  
 CURRENT: 3A FOR VBUS,  
 1.25A FOR GND PIN.  
 0.25A FOR OTHER

VOLTAGE: 20 V MAX  
 WITHSTANDING VOLTAGE: 100V AC R.M.S.  
 CONTACT RESISTANCE: 40mΩ MAX.  
 INSULATION RESISTANCE: 100MΩ MIN.

4. ENVIRONMENTAL  
 TEMPERATURE RANGE -25°C ~ +85°C

5. 尺寸标注事项:  
 图示有标示⊗者为首样全检, 重点管控尺寸.  
 6. 产品符合RoHS标准



B12	GND
B9	VBUS
B5	CC2
A5	CC1
A9	VBUS
A12	GND
PIN	SIGNAL NAME

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>HLW</b> 深圳市华联威电子科技有限公司 HUA LIAN WEI TECHNOLOGY ELECTRONICS CO.,LTD.	
XXX ±0.15 XX ±0.20 X ±0.30	X' ±5' XX' ±2'	PART NAME:	TYPE C 6P沉板1.6
APPROVED		PART No.:	U573-314B-G61018
CHECKED		PROJECTION:	
DRAWN	ZhangFenYan	UNIT:	mm
DATE	2018.10.10	SCALE	1:1
		SHEET	10F1
		REV.	A